

## Model RFP-250-200RM



## Flanged Resistors 250 Watts, 200 Ω



### **Features**

- DC 2.0 GHz
- 250 Watts
- BeO Ceramic
- Welded Silver Leads
- Non-Nichrome Resistive
  Element
- 100% Tested

**Outline Drawing** 

### **General Specifications**

Resistive Element:	Thick film
Substrate:	Beryllium oxide ceramic
Cover:	Alumina ceramic
Mounting Flange:	Copper, nickel plated per
	QQ-N-290
Lead(s):	99.99% pure silver (.005" thk)

### **Electrical Specifications**

Resistance Value:
Frequency Range:
Power:
Capacitance:

200 ohms, ±5% DC - 2.0 GHz 250 Watts 3.3 pF

**Notes:** Tolerance is  $\pm$ .010, unless otherwise specified. Operating temperature is -55°C to +150°C (see chart). Designed to meet or exceed applicable portions of MIL-E-5400. All dimensions are in inches. Lead length 0.15" minimum.

Specifications subject to change without notice.

#### .110 .210 .187 125 .975 .488 **→**+.120 .303-RFP .375 250-200 .1875 RM .120 DIA THRU. (2 PLACES) .370 -.125 .725

VER. 12/5/01

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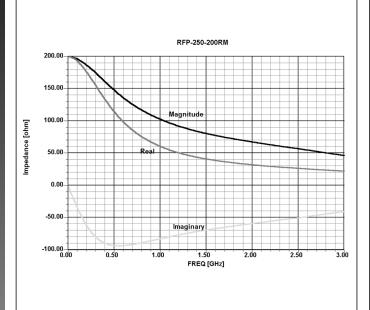


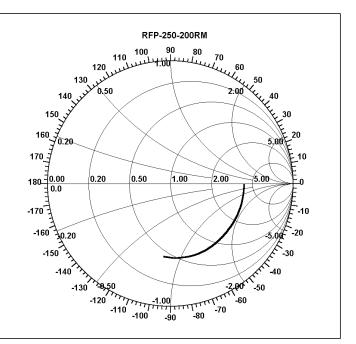
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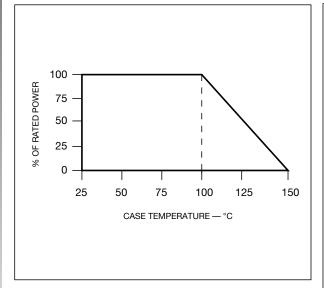


### **Typical Performance**

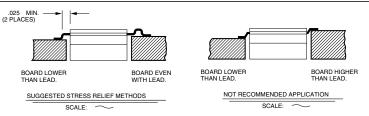




### **Power Derating**



### **Suggested Mounting Procedures**



- 1. Make sure that the devices are mounted on flat surfaces (.001" under the device) to optimize the heat transfer.
- 2. Drill & tap the heatsink for the appropriate thread size to be used.
- 3. Coat heatsink with a minimum amount of high quality silicone grease (.001" max. thickness).
- 4. Position device on mounting surface and secure using socket head screws, flat & split washers. Torque screws to the appropriate value. Make sure that the device is flat against the heatsink. (Care should be taken to avoid upward pressure of the leads towards the lid).
- 5. Solder leads in place using an SN63 type solder with a controlled temperature iron (210°C).



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